PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6773279

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHENG-YEN YU	03/22/2016
CHE-CHENG CHANG	03/22/2016
TUNG-WEN CHENG	03/22/2016
ZHE-HAO ZHANG	03/22/2016
BO-FENG YOUNG	03/22/2016

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO.10 JIUXIANQIAO RD., CHAOYANG DISTRICT,
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17353597

CORRESPONDENCE DATA

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NAME OF SUBMITTER: LYNN CRUZ **SIGNATURE:** /Lynn Cruz/ **DATE SIGNED:** 06/21/2021

Total Attachments: 3

source=4 095714-1432 COMBINED DECLARATION ASSIGNMENT#page1.tif

PATENT REEL: 056608 FRAME: 0841 source=4_095714-1432_COMBINED_DECLARATION_ASSIGNMENT#page2.tif source=4_095714-1432_COMBINED_DECLARATION_ASSIGNMENT#page3.tif

PATENT REEL: 056608 FRAME: 0842



COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

which	application is:
	attached, or
\boxtimes	United States application number or PCT international application number 14/749.597 filed on June 24, 2015.
The at	pove-identified application was made or authorized to be made by me.
	event that the filing date and/or application number are not entered above at the time lee this document, and if such information is deemed necessary, I hereby authorize and

In the event that the filing date and/or application number are not entered above at the time I execute this document, and if such information is deemed necessary, I hereby authorize and request the registered practitioners of McDermott Will & Emery LLP, associated with the Customer Number 20277, to insert above the filing date and/or application number of the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Attorney Docket No. 095714-0029 (P20141435US01)

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.

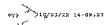
having an address at No. 8 Li-Hsin Rd. 6, Science-Based Industrial Park, Hsinchu 300 TW, (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Page 2 of 3



Attorney Docket No. 095714-0029 (P20141435US01)

Legal name of first inventor	NOTES AND TO CONTROL OF THE AND
Cheng-Yen YU	
First inventor's signature	Date
Cheng - Yen YU	20/6/3/22
Legal name of second inventor, if any	TO THE STATE OF TH
Che-Cheng CHANG	
Second inventor's signature	Date
Cha-Chang Chong	2016/3/22

Legal name of third inventor, if sny	
Tung-Wen CHENG	
Third inventor's signature	Date
Tang - Wen Chong	20(6/3/22
Legal name of fourth inventor, if any	
Zhe-Hao ZHANG	**************************************
Fourth inventor's signature	Date
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Legal name of fifth inventor, if any	
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Fifth inventor's signature	Date
90-Treng YOUNG	2016/3/22

RECORDED: 06/21/2021